

Specific	ation 1		prova	
Cus	tomer :		_	
TAI-TECH P/N	I: WCM4532F	2SV-421T32-HI-ł	1D	
QUANTITY:		pcs		
REMARK:				
	Customer Approva	l Feedback		
■ 西北臺慶科技股份有限公司 TAI-TECH Advanced Electronics Co., Ltd <u>Headquarter:</u> NO.1 YOU 4TH ROAD, YOUTH INDUSTRIAL DISTRICT, Y/ TAO-YUAN HSIEN, TAIWAN, R.O.C. TEL: +886-3-4641148 FAX: +886-3-4643565 http://www.tai-tech.com.tw E-mail: sales@tai-tech.com.tw	ANG-MEI,			
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□ 慶邦電子元器件(泗洪)有限公司 TAIPAQ ELECTRONICS (SIHONG) CO., LTD		APPROVED	CHECKED	DRAWN
Sihong development zone Suqian City, Jiangsu , CHINA. TEL: +86-527-88601191 FAX: +86-527-88601190 E-mail: sales@taipaq.cn		楊祥忠 Mike Yang	林志鴻 Zhi-Hong Lin	林靜婷 Michelle Lim
		L	<u> </u>	

Wire Wound Type Common Mode Filter WCM4532F2SV-421T32-HI-HD

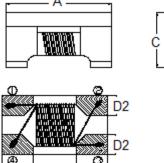
	ECN HISTORY LIST							
REV	DATE	DESCRIPTION	APPROVED	CHECKED	DRAWN			
1.0	24/01/31	新發行	楊祥忠	林志鴻	林靜婷			
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Wire Wound Type Common Mode Filter WCM4532F2SV-421T32-HI-HD

1. Features

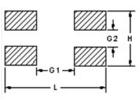
- 1. High common mode impedance at high frequency cause excellent noise suppression performance.
- 2. WCM4532F2SV series realizes small size and low profile. 4.5x3.2x2.8 mm.
- 3. 100% Lead(Pb) & Halogen-Free and RoHS compliant.
- 4. High reliability -Reliability tests comply with AEC-Q200
- 5. Operating temperature -55~+125°C (Including self temperature rise)

2. Dimension



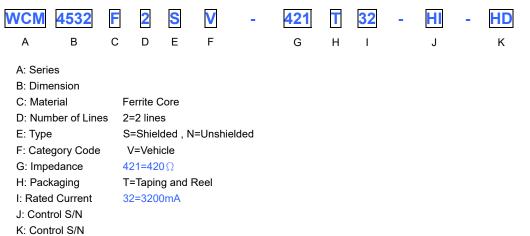


Recommended PC Board Pattern



Series	A(mm)	B(mm)	C(mm)	D1(mm)	D2(mm)	L(mm)	H(mm)	G1(mm)	G2(mm)
4532F2SV	4.5±0.2	3.2±0.2	2.8±0.2	0.90±0.15	1.05±0.15	5.0	3.6	3.0	1.2
Units: mm									

3. Part Numbering

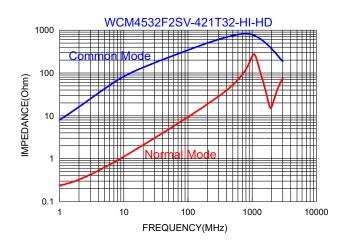


4. Specification

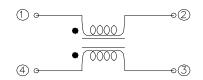
TAI-TECH Part Number	Commo Impeda	n mode nce (Ω)	Test Frequency (MHz)	DC Resistance (Ω) max.	Rated Current (mA) max.	Rated Volt. (Vdc) max.	Withstand Volt. (Vdc) max.	IR (Ω) min.
WCM4532F2SV-421T32-HI-HD	300 min	420 typ.	100	0.055	3200	50	125	10M

Note: When current is applied , the temperature of the part should not exceed $125^\circ\!\!\mathbb{C}$



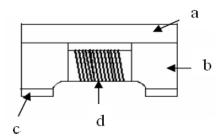


5. Schematic Diagram



6. Materials

No.	Description	Specification
a.	Upper Plate	Ferrite
b.	Core	Ferrite Core
с	Termination	Ag/Ni/Sn
d	Wire	Enameled Copper Wire



7. Reliability and Test Condition

Item	Performance	Test Condition				
Operating temperature	-55~+125 $^\circ\!\mathbb{C}$ (Including self - temperature rise)					
Storage temperature	-55~+125℃ (on board)					
Electrical Performance Tes	Electrical Performance Test					
Z(common mode)		Keysight E4991B + Keysight 16197A				
DCR	Refer to standard electrical characteristics list.	Agilent-34420A Agilent-4338B				
I.R.		Chroma 19073				
Temperature Rise Test	Rated Current $, \Delta T : 40^\circ C$ typ.	1.Applied the allowed DC current. 2.Temperature measured by digital surface thermometer				

		Preconditioning: Run through reflow for	
		J-STD-020F Classification Reflow Profil Unpowered	es)
		Temperature : 125±2℃	
High Temperature		Upper Temperature: maximum specified	
Exposure(Storage) AEC-Q200		Minimum toot temperature shall be 85%	
		Minimum test temperature shall be 85°C suppressors/filters only)	
		Duration : 1000hrs Min.	
		Measured at room temperature after pla	
		Preconditioning: Run through reflow for	
		J-STD-020F Classification Reflow Profil Unpowered	es)
		Lower Temperature of the Chamber:	
		-40°C (For Inductors/Transformers)	\ \
		-55°C (For ferrite EMI suppressors/filters Upper Temperature of the Chamber: ma	
		temperature and shall not exceed 125°C	
Temperature Cycling		Condition for 1 cycle	
AEC-Q200		Step1 : -55±2℃ 30min Min. Step2 : 125±2℃ transition time 1min M	
		Step2 : 125 ± 2 °C anisation time minimum Step3 : 125 ± 2 °C 30min Min.	AA.
	Appearance:No damage.	Step4 : Dwell Time (Soak Time)	
	Impedance : within±15% of initial value	15 minutes minimum,	
	RDC : within±15% of initial value and shall not exceed the	30 minutes minimum if component Transition Time: 1 minute maximum	nt weighs above 28g
	specification value	Number of cycles : 1000	
	1	Measured at room temperature at least	
		Preconditioning: Run through reflow for J-STD-020F Classification Reflow Profil	
		Unpowered(For Inductors/Transformers	
		Apply 10% of maximum rated power.(F	
Humidity Bias (AEC-Q200)		suppressors/filters)	
(ALC-0200)		Humidity : 85±3% R.H,	
		Temperature : 85℃±2℃	
		Duration: 1000hrs Min. Measured at room temperature after pla	cing for 24+4hrs
	4	Preconditioning: Run through reflow for	
		J-STD-020F Classification Reflow Profil	es)
		Temperature : 125±2℃	
High Temperature		Upper Temperature of the Chamber: ma temperature (not including heat rise) at r	
Operating Life		not exceed 125°C.(For Inductors/Trans	
(AEC-Q200)		Temperature of the Chamber: maximum	n specified operating
		temperature up to 150°C (For ferrite EN Duration : 1000hrs Min. with 100% rate	
		Measured at room temperature after pla	
		Rated IL applied (For ferrite EMI suppre	essors/filters)
Enternal Marcal	Anne and the demand	Inspect device construction, marking an	d workmanship. Pre and
External Visual	Appearance : No damage.	Electrical Test not required.	·
Physical Dimension	According to the product specification size measurement	Verify physical dimensions to the	applicable component
Physical Dimension	According to the product specification size measurement	specification. Pre and Post Electrical Te	st not required.
		Test THT component lead integrity only. Test Condition A (pull test)	
		Nominal cross- sectional	Force (N)
		area (mm²)	
		<u>≤ 0.05</u>	<u>1</u>
		<u>0.06 to 0.10</u>	<u>2.5</u>
		<u>0.11 to 0.20</u>	<u>5</u>
		<u>0.21 to 0.50</u>	<u>10</u>
		<u>0.51 to 1.20</u>	<u>20</u>
		<u>> 1.20</u>	<u>40</u>
Terminal Strength	Appearance : No damage.	Test Condition C (wire-lead bend test):	
or axial and radial THT components)	Impedance : within±15% of initial value RDC : within±15% of initial value and shall not exceed the	Section Modulus (Zx) (mm ³)	Force (N)
sompononio)	specification value	≤ 1.5x10 ⁻³	0.5
		1.6x10 ⁻³ to 4.2x10 ⁻³	1.25
		4.3x10 ⁻³ to 1.2x10 ⁻²	2.5
		1.3x10 ⁻² to 0.5x10 ⁻¹	5
		0.6x10 ⁻¹ to 1.9x10 ⁻¹	<u></u> <u>10</u>
		> 1.9x10 ⁻¹	20
		<u> </u>	
		For round terminations: $ZX = (\pi d3)/32 v$	where d is the lead diame

Item	Performance			Test C	onditio	on	
Resistance to Solvents		recommer	ided paramet	ers (i.e. solutio	n tempera	mical manufactur ature and immers aser marked com	ion time).
		Туре	Peak value (g's)	Normal duration (D) (ocity (Vi)ft/sec
Mechanical Shock		SMD	100	6		-	2.3
Mechanical Shock		THT	100	6	На	If-sine 1	2.3
Vibration	-	(18 shoc Precondition Classificat Oscillation Equipmen Total Amp	ks). oning: Run th ion Reflow P Frequency : t : Vibration c litude : 5g me : 12 hours	rough reflow fo rofiles) 10Hz~2kHz~ hecker	r 3 times. 10Hz for	ndicular axes. (IPC/JEDEC J-S 20 minutes each of 3 orientat	
			litions B or C				
		Solder techniqu simulatio	e lest	Temperature (℃)	Time(s)	Temperature ramp/immersion and emersion rate	Number of heat cycles
	Appearance ∺ No damage.	Dip	В	260 ±5 (solder temp)	10±1	25mm/s ±6mm/s	1
	Impedance : within±15% of initial value RDC : within±15% of initial value and shall not exceed the specification value	Wave: Topside board-mo nt produc	bu C	260 ±5 (solder temp)	20±1		1
Resistance to Soldering Heat		SMD: Con Continenta Tempera composi- co	the second secon	T _{Smax} t _s	60s-150s	2250°C 23008 23008 250°C 23008 250°C	ang down Ang from Mar 1105 Mar 11
ESD		Discharge Test methe Test mode		a Coaxial Targ 0-002 ischarge			ESD

Item	Performance		Test	Condition		
		Through-hole Technology (THT: Method A1, Coating Durability Category 2) SMD: Method B1, Coating Durability Category 2 Method D, Coating Durability Category 2 • Magnification 50x • Pre and Post Electrical Test not required. • Non-soldered type mounting/attach are not applicable.				
		参照	Method A1	Method B1	Method D	
		焊接工藝	再流焊	其他器件的再流焊	無鉛銲接	
Solderability	More than 95% of the terminal electrode should be covered with solder	焊接類型	錫銀銅焊料	錫銀銅焊料	錫銀銅焊料	
		浸入助焊劑時	5-10s	5-10s	5-10s	
		浸入錫爐角度	20°~45°	20°~45°	20°~45°	
		焊料溫度	245±5°C	245±5°C	260±5°C	
		浸入焊料時間	5+0/-0.5s	5+0/-0.5s	30+5/-0s	
		浸入和提出速	25±6mm/s	25±6mm/s	25±6mm/s	
Electrical Characterization	Refer Specification for Approval	Parametrically test per lot and sample size requirements, summary to show Mii Max, Mean and Standard deviation at room as well as Min and Max operatin temperatures. Pre and Post Electrical Test not required				
Board Flex (SMD)	Appearance : No damage. Impedance : within±15% of initial value RDC : within±15% of initial value and shall not exceed the specification value	Figure with the and mechanical mean minimum. The dur to be applied only Support	X 40mm board in component facin s to apply a force ation of the appli once to the board Solder Chip	Printed circuit board before	tus shall consist of board (D) x = 2 mm + 5) sec. The force is testing	
Terminal Strength(SMD)		Classification Refle With the component 17.7 N (1.8 Kg) for	w Profiles) nt mounted on a ce to the side of econds. Also the e component be raclius 0,5 m	m wide ess tool	be tested, apply a This force shall be gradually as not to	

8. Soldering and Mounting

8-1. Soldering

Mildly activated rosin fluxes are preferred. TAI-TECH terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

8-1.1 Soldering Reflow:

Recommended temperature profiles for lead free re-flow soldering in Figure 1. Table 1.1&1.2 (J-STD-020E)

8-1.2 Soldering Iron(Figure 2):

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended. (Figure 2.)

Preheat circuit and products to 150°C
 • Never contact the ceramic with the iron tip
 • 350°C tip temperature (max)
 • 1.0mm tip diameter (max)
 • Limit soldering time to 4~5sec.

Fig.1 Soldering reflow

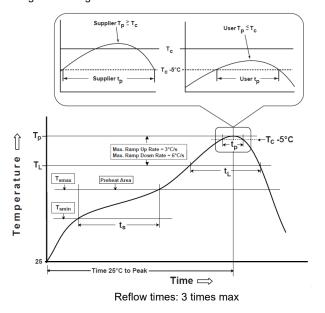


Fig.2 Iron soldering temperature profiles

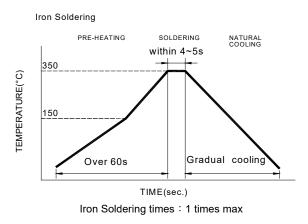


Table	(1.1):	Reflow	Profiles
-------	--------	--------	----------

Profile Type:	Pb-Free Assembly
Preheat -Temperature Min(T _{smin}) -Temperature Max(T _{smax}) -Time(t _s)from(T _{smin} to T _{smax})	150℃ 200℃ 60-120seconds
Ramp-up rate(T₋to T _p)	3℃/second max.
Liquidus temperature(TL) Time(tL)maintained above TL	217℃ 60-150 seconds
Classification temperature(T_c)	See Table (1.2)
$Time(t_p)$ at Tc- $5^\circ\!\mathbb{C}$ (Tp should be equal to or less than Tc.)	< 30 seconds
Ramp-down rate(T_p to T_L)	6℃/second max.
Time 25 $^\circ\!\mathbb{C}$ to peak temperature	8 minutes max.

 $\mathbf{Tp}:$ maximum peak package body temperature, $\mathbf{Tc}:$ the classification temperature.

For user (customer) ${\bf Tp}$ should be equal to or less than ${\bf Tc.}$

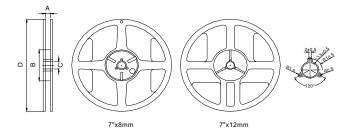
Table (1.2) Package Thickness/Volume and Classification Temperature (T_c)

	Package Thickness	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm ³ >2000
	<1.6mm	260°C	260°C	260°C
PB-Free Assembly	1.6-2.5mm	260°C	250°C	245°C
	≥2.5mm	250°C	245°C	245°C

Reflow is referred to standard IPC/JEDEC J-STD-020E .

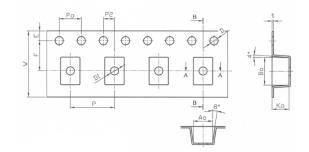
9. Packaging Information

9-1. Reel Dimension



Туре	A(mm)	B(mm)	C(mm)	D(mm)
7"x12mm	13.5±0.5	60.0±2.0	13.5±0.5	178.0±2.0

9-2. Tape Dimension / 12mm

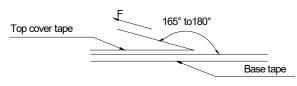


Series	P(mm)	Po(mm)	P2(mm)	Bo(mm)	Ao(mm)	Ko(mm)	D(mm)	E(mm)	F(mm)	W(mm)	t(mm)	D1(mm)
WCM4532F2S	8.00±0.10	4.00±0.10	2.00±0.05	4.90±0.10	3.60±0.10	3.00±0.10	1.50+0.10/-0.00	1.75±0.10	5.50±0.05	12.00±0.10	0.26±0.05	1.50±0.10

9-3. Packaging Quantity

Chip size	Chip/Reel	Inner Box	Middle Box	Carton
WCM4532F2S	500	2000	10000	20000

9-4. Tearing Off Force



The force for tearing off cover tape is 15 to 80 grams	
in the arrow direction under the following conditions.	

Room Temp.	Room Humidity	Room atm	Tearing Speed
(°C)	(%)	(hPa)	mm/min
5~35	45~85	860~1060	300

Application Notice

- Storage Conditions(component level)
 - To maintain the solderability of terminal electrodes:
 - 1. TAI-TECH products meet IPC/JEDEC J-STD-020F standard-MSL, level 1.
 - 2. Temperature and humidity conditions: Less than 40 $^\circ\!{\rm C}$ $\,$ and 60% RH.
 - 3. Recommended products should be used within 12 months form the time of delivery.
 - 4. The packaging material should be kept where no chlorine or sulfur exists in the air.

Transportation

- 1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- 2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
- 3. Bulk handling should ensure that abrasion and mechanical shock are minimized.





Test Report

號碼(No.): ETR23302694

日期(Date): 17-Mar-2023

頁數(Page):1 of 15

西北臺慶科技股份有限公司 (TAI-TECH ADVANCED ELECTRONICS CO., LTD.) 臺慶精密電子(昆山)有限公司 (TAI-TECH ADVANCED ELECTRONICS (KUN-SHAN) CO. LTD.) 慶邦電子元器件 (泗洪) 有限公司 (TAI-PAQ ELECTRONICS (SI-HONG) CO., LTD.) 桃園市楊梅區幼獅工業區幼四路1號 (NO. 1, YOU 4TH ROAD, YOUTH INDUSTRIAL DISTRICT, YANG-MEI, TAO-YUAN CITY, TAIWAN R. O. C.) 江蘇省昆山市篷朗昆嘉高科技工業區郭澤路 (GUO-ZE ROAD, KUNJIA HI-TECH INDUSTRIAL PARK, KUN-SHAN, JIANG-SU, CHINA) 中國,江蘇省,宿遷市,泗洪縣,經濟開發區杭州路南側,建設北路東側 (THE SOUTH HANGZHOU ROAD AND THE EAST JIANSHE ROAD, ECONOMIC DEVELOPMENT ZONE, SIHONG COUNTY, SUQIANCITY, JIANGSU PROVINCE

· P.R · CHINA)

以下測試樣品係由申請廠商所提供及確認 (The following sample(s) was/were submitted and identified by the applicant as):

樣品名稱(Sample Name) 樣品型號(Style/Item No.)	:	WIREWOUND SERIES WCM(YCW) \ WCL \ HSF \ HDMI \ DVI \ BCM \ PCM \ TCM \ LCM \ LPF \ TXF \ ACM \ DCM(YLW) \ WIH \ BPH \ TNH \ YCM \ STF \ APO \ QLL \ FGO \ APOC \ TLAN SERIES
=====================================	===== : :	10-Mar-2023 10-Mar-2023 to 17-Mar-2023
測試需求(Test Requested) :		依據客戶要求進行測試 測試項目請參閱測試結果表格。 (Testing item(s) is/are specified by client. Please refer to result table for testing item(s).)
測試結果(Test Results) :		請參閱下一頁 (Please refer to following pages.)

Froy Chang / Department Ma Signed for and on behalf 🕅 AIWA SGS TAIWAN LTD. Chemical Laboratory - Taipei



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Member of the SGS Group



Test Report

號碼(No.): ETR23302694

日期(Date): 17-Mar-2023

頁數(Page): 2 of 15

西北臺慶科技股份有限公司 (TAI-TECH ADVANCED ELECTRONICS CO., LTD.)

臺慶精密電子(昆山)有限公司 (TAI-TECH ADVANCED ELECTRONICS (KUN-SHAN) CO. LTD.)

慶邦電子元器件 (泗洪) 有限公司 (TAIPAQ ELECTRONICS (SI-HONG) CO., LTD.)

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江蘇省昆山市篷朗昆嘉高科技工業區郭澤路 (GUO-ZE ROAD, KUNJIA HI-TECH INDUSTRIAL PARK, KUN-SHAN, JIANG-SU, CHINA)

中國,江蘇省,宿遷市,泗洪縣,經濟開發區杭州路南側,建設北路東側 (THE SOUTH HANGZHOU ROAD AND THE EAST JIANSHE ROAD, ECONOMIC DEVELOPMENT ZONE, SIHONG COUNTY, SUQIANCITY, JIANGSU PROVINCE, P,R, CHINA)

測試部位敘述 (Test Part Description)

No.1 : 整體混測 (MIXED ALL PARTS)

測試結果 (Test Results)

測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result) No.1
鎘 (Cd) (Cadmium (Cd))	參考IEC 62321-5: 2013,以感應耦合電漿發射光 譜儀分析。(With reference to IEC 62321-5: 2013, analysis was performed by ICP-OES.)	mg/kg	2	n.d.
鉛 (Pb) (Lead (Pb))	參考IEC 62321-5: 2013,以感應耦合電漿發射光 譜儀分析。(With reference to IEC 62321-5: 2013, analysis was performed by ICP-OES.)	mg/kg	2	n.d.
汞 (Hg) (Mercury (Hg))	参考IEC 62321-4: 2013+ AMD1: 2017,以感應耦 合電漿發射光譜儀分析。(With reference to IEC 62321-4: 2013+ AMD1: 2017, analysis was performed by ICP-OES.)	mg/kg	2	n.d.
六價鉻 Cr(VI) (Hexavalent Chromium Cr(VI))	参考IEC 62321-7-2: 2017 · 以紫外光-可見光分光 光度計分析。(With reference to IEC 62321-7-2: 2017, analysis was performed by UV-VIS.)	mg/kg	8	n.d.

SGS Taiwan Etd. 台灣设驗科技股份資限公司

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SG

Test Report

號碼(No.): ETR23302694

日期(Date): 17-Mar-2023

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西北臺慶科技股份有限公司 (TAI-TECH ADVANCED ELECTRONICS CO., LTD.)

臺慶精密電子(昆山)有限公司 (TAI-TECH ADVANCED ELECTRONICS (KUN-SHAN) CO. LTD.)

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桃園市楊梅區幼獅工業區幼四路1號 (NO. 1, YOU 4TH ROAD, YOUTH INDUSTRIAL DISTRICT, YANG-MEI, TAO-YUAN CITY, TAIWAN R. O. C.)

江蘇省昆山市篷朗昆嘉高科技工業區郭澤路 (GUO-ZE ROAD, KUNJIA HI-TECH INDUSTRIAL PARK, KUN-SHAN, JIANG-SU, CHINA)

中國,江蘇省,宿遷市,泗洪縣,經濟開發區杭州路南側,建設北路東側 (THE SOUTH HANGZHOU ROAD AND THE EAST JIANSHE ROAD, ECONOMIC DEVELOPMENT ZONE, SIHONG COUNTY, SUQIANCITY, JIANGSU PROVINCE, P,R, CHINA)

測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result) No.1
—————————————————————————————————————		mg/kg	5	n.d.
二溴聯苯 (Dibromobiphenyl)		mg/kg	5	n.d.
三溴聯苯 (Tribromobiphenyl)		mg/kg	5	n.d.
四溴聯苯 (Tetrabromobiphenyl)		mg/kg	5	n.d.
五溴聯苯 (Pentabromobiphenyl)		mg/kg	5	n.d.
六溴聯苯 (Hexabromobiphenyl)		mg/kg	5	n.d.
七溴聯苯 (Heptabromobiphenyl)		mg/kg	5	n.d.
八溴聯苯 (Octabromobiphenyl)		mg/kg	5	n.d.
九溴聯苯 (Nonabromobiphenyl)		mg/kg	5	n.d.
十溴聯苯 (Decabromobiphenyl)		mg/kg	5	n.d.
多溴聯苯總和 (Sum of PBBs)	一参考尼C 02321-0. 2013 · 以黑柏層研展/頁語展/了	mg/kg	-	n.d.
一溴聯苯醚 (Monobromodiphenyl ether)	analysis was performed by GC/MS.)	mg/kg	5	n.d.
二溴聯苯醚 (Dibromodiphenyl ether)	analysis was performed by GC/103.)	mg/kg	5	n.d.
三溴聯苯醚 (Tribromodiphenyl ether)		mg/kg	5	n.d.
四溴聯苯醚 (Tetrabromodiphenyl ether)		mg/kg	5	n.d.
五溴聯苯醚 (Pentabromodiphenyl ether)		mg/kg	5	n.d.
六溴聯苯醚 (Hexabromodiphenyl ether)		mg/kg	5	n.d.
七溴聯苯醚 (Heptabromodiphenyl ether)		mg/kg	5	n.d.
八溴聯苯醚 (Octabromodiphenyl ether)		mg/kg	5	n.d.
九溴聯苯醚 (Nonabromodiphenyl ether)		mg/kg	5	n.d.
十溴聯苯醚 (Decabromodiphenyl ether)		mg/kg	5	n.d.
多溴聯苯醚總和 (Sum of PBDEs)		mg/kg	-	n.d.

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SGS Taiwan Ltd. 台灣檢驗科技股份有限公司

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測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result) No.1
鄰苯二甲酸丁苯甲酯 (BBP) (Butyl benzyl phthalate (BBP))		mg/kg	50	n.d.
鄰苯二甲酸二丁酯 (DBP) (Dibutyl phthalate (DBP))		mg/kg	50	n <i>.</i> d.
鄰苯二甲酸二(2-乙基己基)酯 (DEHP) (Di- (2-ethylhexyl) phthalate (DEHP))		mg/kg	50	n.d.
鄰苯二甲酸二異丁酯 (DIBP) (Dilsobutyl phthalate (DIBP))		mg/kg	50	n.d.
鄰苯二甲酸二異癸酯 (DIDP) (Diisodecyl phthalate (DIDP)) (CAS No.: 26761-40- 0, 68515-49-1)	参考IEC 62321-8: 2017,以氣相層析儀/質譜儀分 析。(With reference to IEC 62321-8: 2017,	mg/kg	50	n.d.
鄰苯二甲酸二異壬酯 (DINP) (Diisononyl phthalate (DINP)) (CAS No.: 28553-12- 0, 68515-48-0)	analysis was performed by GC/MS.)	mg/kg	50	n.d.
鄰苯二甲酸二正辛酯 (DNOP) (Di-n-octyl phthalate (DNOP)) (CAS No.: 117-84-0)		mg/kg	50	n.d.
鄰苯二甲酸二正戊酯 (DNPP) (Di-n- pentyl phthalate (DNPP)) (CAS No.: 131-18-0)		mg/kg	50	n.d.
鄰苯二甲酸二正己酯 (DNHP) (Di-n-hexyl phthalate (DNHP)) (CAS No.: 84-75-3)		mg/kg	50	n.d.

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SGS Taiwan Ltd. 台灣樹齡科枝股份有限公司



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測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result) No.1
六溴環十二烷及所有主要被辨別出的異構 物(HBCDD) (α- HBCDD, β- HBCDD, γ- HBCDD) (Hexabromocyclododecane (HBCDD) and all major diastereoisomers identified (α- HBCDD, β- HBCDD, γ- HBCDD)) (CAS No.: 25637-99-4, 3194-55-6 (134237-51-7, 134237-50-6, 134237-52-8))	参考IEC 62321-9: 2021.以氣相層析儀/質譜儀分 析。(With reference to IEC 62321-9: 2021, analysis was performed by GC/MS.)	mg/kg	20	n.d.
氟 (F) (Fluorine (F)) (CAS No.: 14762-94- 8)		mg/kg	50	n.d.
氯 (Cl) (Chlorine (Cl)) (CAS No.: 22537- 15-1)	参考BS EN 14582:2016,以離于層研懷分析。 - (With reference to BS EN 14582:2016 analysis —	mg/kg	50	n.d.
溴 (Br) (Bromine (Br)) (CAS No.: 10097- 32-2)		mg/kg	50	n.d.
碘 (I) (lodine (I)) (CAS No.: 14362-44-8)	* 	mg/kg	50	n.d.
全氟辛烷磺酸及其鹽類 (PFOS and its salts) (CAS No.: 1763-23-1 and its salts)	参考CEN/TS 15968: 2010,以液相層析串聯質譜	mg/kg	0.01	n.d.
全氟辛酸及其鹽類 (PFOA and its salts) (CAS No.: 335-67-1 and its salts)	儀分析。(With reference to CEN/TS 15968: 2010, analysis was performed by LC/MS/MS.)	mg/kg	0.01	n.d.
銻 (Sb) (Antimony (Sb)) (CAS No.: 7440- 36-0)	参考US EPA 3052: 1996,以感應耦合電漿發射光	mg/kg	2	82.3
皷 (Be) (Beryllium (Be)) (CAS No.: 7440- 41-7)	譜儀分析。(With reference to US EPA 3052: 1996, analysis was performed by ICP-OES.)	mg/kg	2	n.d.

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SGS Taiwan Ltd. 台灣檢驗科技股份有限公司。

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測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result) No.1
聚氯乙烯 (Polyvinyl chloride) (PVC)	参考ASTM E1252: 2021,以傅立葉轉換紅外線光 譜儀及焰色法分析。(With reference to ASTM E1252: 2021, analysis was performed by FT-IR and Flame Test.)	**	-	Negative

備註(Note):

- 1. mg/kg = ppm ; 0.1wt% = 0.1% = 1000ppm
- 2. MDL = Method Detection Limit (方法偵測極限值)
- 3. n.d. = Not Detected (未檢出); 小於MDL / Less than MDL
- 4. "-" = Not Regulated (無規格值)
- 5. **= Qualitative analysis (No Unit) 定性分析(無單位)
- 6. Negative = Undetectable 陰性(未偵測到); Positive = Detectable 陽性(已偵測到)
- 7. 全氟辛烷磺酸及其鹽類包含等物質 (PFOS and its salts including): CAS No.: 1763-23-1, 2795-39-3, 29457-72-5, 29081-56-9, 70225-14-8, 56773-42-3, 251099-16-8, 307-35-7, 91036-71-4, 4021-47-0 and others.
- 8. 全氟辛酸及其鹽類包含等物質 (PFOA and its salts including): CAS No.: 335-67-1, 335-95-5, 2395-00-8, 335-93-3, 335-66-0, 3825-26-1 and others.
- 9. 樣品的測試是基於申請人要求混合測試,報告中的混合測試結果不代表其中個別單一材質的含量。 The sample(s) was/were analyzed on behalf of the applicant as mixing sample in one testing. The above result(s) was/were only given as the informality value.

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SGS Taiwan Ltd. 台湾检验科技般份有限公司

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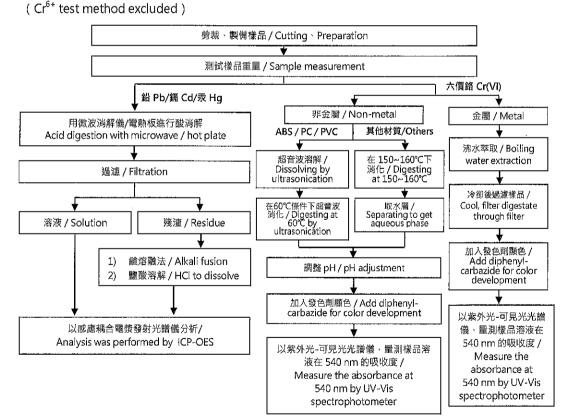
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重金屬流程圖 / Analytical flow chart of heavy metal

根據以下的流程圖之條件,樣品已完全溶解。(六價鉻測試方法除外)

These samples were dissolved totally by pre-conditioning method according to below flow chart.



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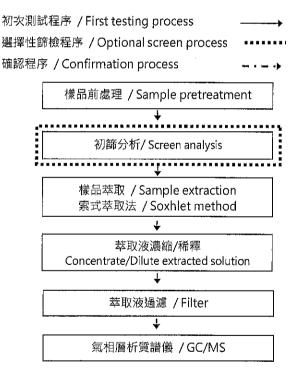
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多溴聯苯/多溴聯苯醚分析流程圖 / Analytical flow chart - PBBs/PBDEs



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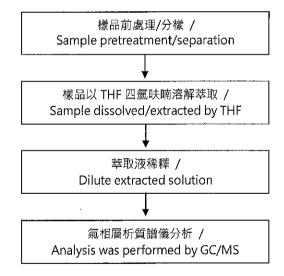
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可塑劑分析流程圖 / Analytical flow chart - Phthalate



【測試方法/Test method: IEC 62321-8】

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Test Report

號碼(No.): ETR23302694

日期(Date): 17-Mar-2023

頁數(Page): 10 of 15

西北臺慶科技股份有限公司 (TAI-TECH ADVANCED ELECTRONICS CO., LTD.)

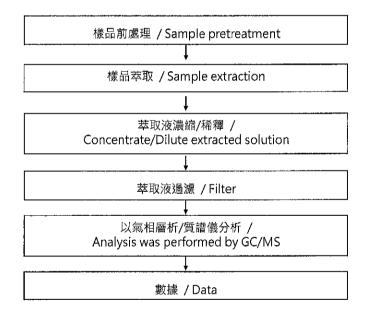
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六溴環十二烷分析流程圖 / Analytical flow chart - HBCDD

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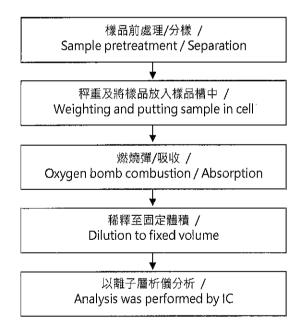
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鹵素分析流程圖 / Analytical flow chart - Halogen

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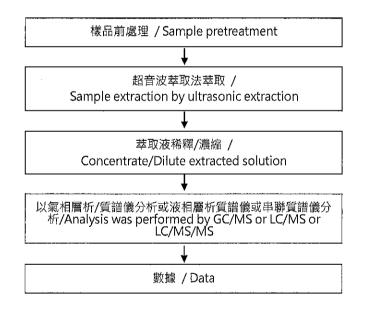
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全氟化合物(包含全氟辛酸/全氟辛烷磺酸/其相關化合物等等)分析流程圖 / Analytical flow chart – PFAS (including PFOA/PFOS/its related compound, etc.)



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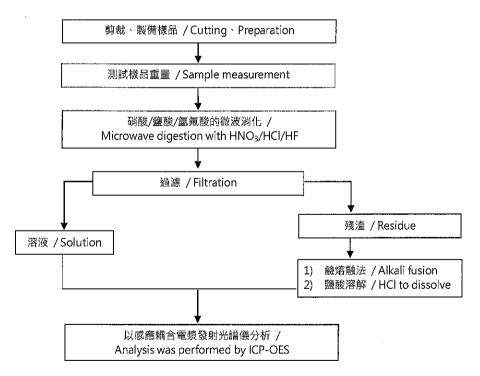
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元素(含重金屬)分析流程圖 / Analytical flow chart of elements (Heavy metal included)

根據以下的流程圖之條件,樣品已完全溶解。

These samples were dissolved totally by pre-conditioning method according to below flow chart.



【参考方法/Reference method: US EPA 3051A、US EPA 3052】

* US EPA 3051A 方法未添加氫氟酸 / US EPA 3051A method does not add HF.

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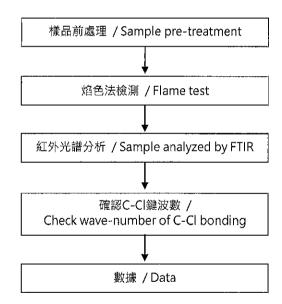
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聚氯乙烯物質判定分析流程圖 / Analysis flow chart - PVC

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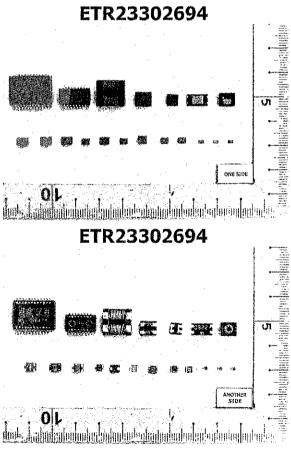
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* 照片中如有箭頭標示,則表示為實際檢測之樣品/部位. * (The tested sample / part is marked by an arrow if it's shown on the photo.)



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